STF28N60DM2



N-channel 600 V, 0.13 Ω typ., 21 A MDmesh[™] DM2 Power MOSFET in a TO-220FP package

Datasheet - production data

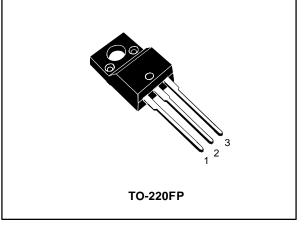
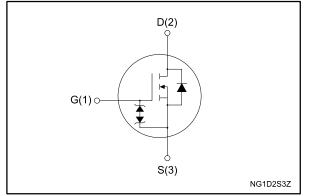


Figure 1: Internal schematic diagram



This is information on a product in full production.

Features

Order code	V _{DS} @ T _{Jmax.}	R _{DS(on)} max.	ID	Ртот
STF28N60DM2	650 V	0.16 Ω	21 A	30 W

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

• Switching applications

Description

This high voltage N-channel Power MOSFET is part of the MDmesh[™] DM2 fast recovery diode series. It offers very low recovery charge (Qrr) and time (trr) combined with low R_{DS(on)}, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

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Order code	Marking	Package	Packing	
STF28N60DM2	28N60DM2	TO-220FP	Tube	

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
1-	Drain current (continuous) at T _{case} = 25 °C	21	٨
lo	Drain current (continuous) at T _{case} = 100 °C	14	A
IDM ⁽¹⁾	Drain current (pulsed)	84	А
Ртот	Total dissipation at T _{case} = 25 °C	30	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	50	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	v/ns
Viso ⁽⁴⁾	Insulation withstand voltage (RMS) from all three leads to external heat sink	2.5	kV
T _{stg}	Storage temperature	55 to 150	°C
Tj	Operating junction temperature	-55 to 150	°C

Notes:

 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ Isp \leq 21 A, di/dt=900 A/µs; Vps peak < V(BR)pss,Vpp = 400 V

 $^{(3)}$ V_{DS} \leq 480 V.

⁽⁴⁾t = 1 s; Tc = 25 °C

Table 3: Thermal data

Symbol	Parameter	Value	Unit		
R _{thj-case}	Thermal resistance junction-case	4.2	°C 11/		
Rthj-amb	Thermal resistance junction-ambient	62.5	°C/W		

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
lar ⁽¹⁾	Avalanche current, repetitive or not repetitive	4	А
E _{AS} ⁽²⁾	Single pulse avalanche energy	350	mJ

Notes:

⁽¹⁾ pulse width limited by T_{jmax}

 $^{(2)}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	600			V
	Zoro goto voltago	$V_{GS} = 0 V, V_{DS} = 600 V$			1	
IDSS	Zero gate voltage drain current	V _{GS} = 0 V, V _{DS} = 600 V, T _{case} = 125 °C			100	μA
lgss	Gate-body leakage current	$V_{DS} = 0 V$, $V_{GS} = \pm 25 V$			±10	μA
$V_{\text{GS(th)}}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10.5 \text{ A}$		0.13	0.16	Ω

Table 6: Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1500	-	
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	70	-	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V	-	1.6	-	P
Coss eq. ⁽¹⁾	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	-	134	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	4.6	-	Ω
Qg	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 21 \text{ A},$	-	34	-	
Qgs	Gate-source charge	V _{GS} = 10 V (see Figure 15: "Test circuit for gate charge	-	8	-	nC
Q _{gd}	Gate-drain charge	behavior")	-	18.5	-	

Notes:

 $^{(1)}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80% VDSs.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 10.5 \text{ A}$	-	16	-		
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Test circuit for	-	7.3	-		
t _{d(off)}	Turn-off delay time	resistive load switching times"	-	53	-	ns	
t _f	Fall time	and Figure 19: "Switching time waveform")	-	9.3	-		

Table 7: Switching times





Electrical characteristics

	Table 8: Source-drain diode							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
I _{SD} ⁽¹⁾	Source-drain current		-		21	А		
I _{SDM} ⁽²⁾	Source-drain current (pulsed)		-		84	А		
Vsd ⁽³⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 21 A	-		1.6	V		
trr	Reverse recovery time	I _{SD} = 21 A, di/dt = 100 A/µs,	-	140		ns		
Qrr	Reverse recovery charge	$V_{DD} = 60 V$ (see Figure 16: "Test circuit for inductive load	-	0.5		μC		
Irrm	Reverse recovery current	switching and diode recovery times")	-	7.4		А		
trr	Reverse recovery time	I _{SD} = 21 A, di/dt = 100 A/µs,	-	309		ns		
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	2.6		μC		
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	16.8		А		

Notes:

⁽¹⁾ Limited by maximum junction temperature.

 $^{\left(2\right) }$ Pulse width is limited by safe operating area.

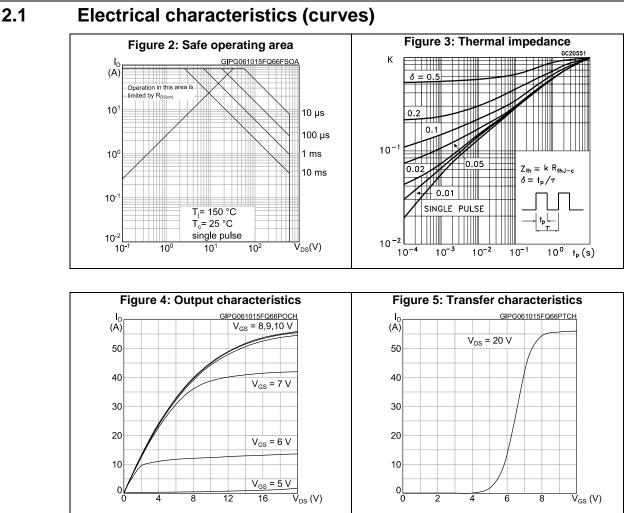
 $^{(3)}$ Pulse test: pulse duration = 300 µs, duty cycle 1.5%.

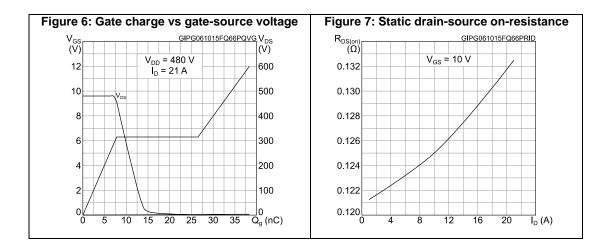
Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _(BR) GSO	Gate-source breakdown voltage	$I_{GS} = \pm 250 \ \mu A, I_D = 0 \ A$	±30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.



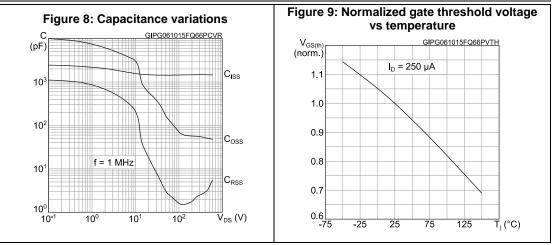


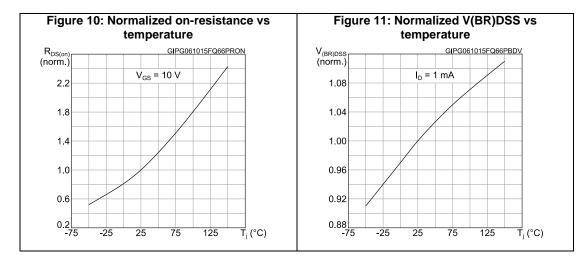


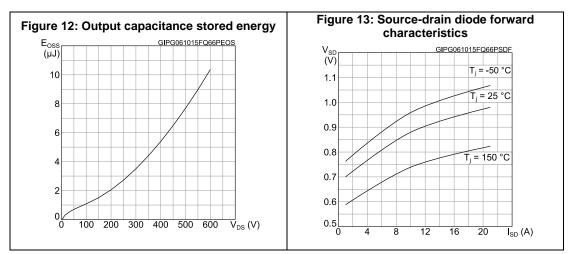
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Electrical characteristics

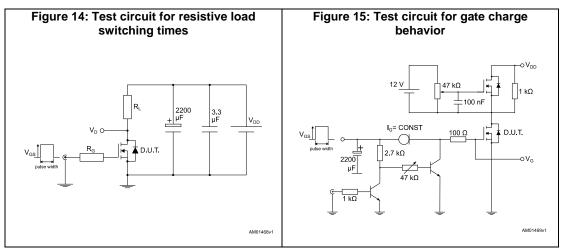


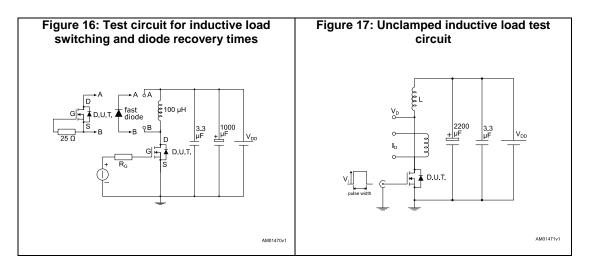


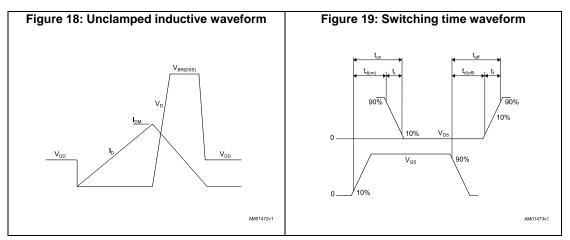


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3 Test circuits







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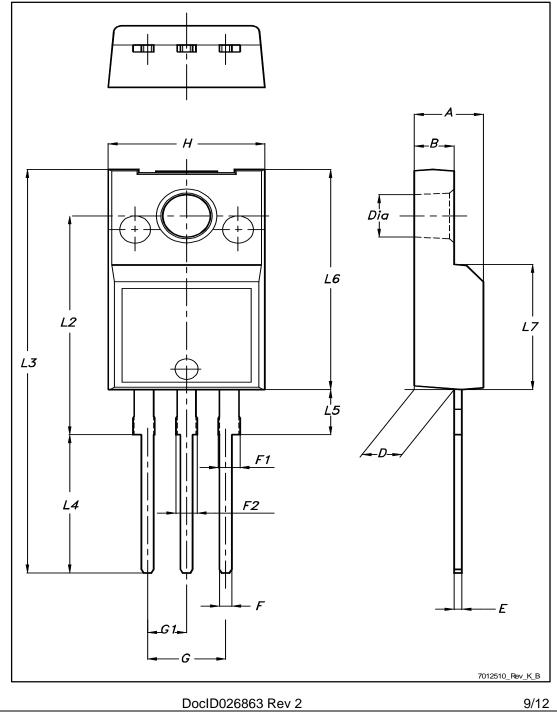
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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-220FP package information

Figure 20: TO-220FP package outline



Package information

Table 10: TO-220FP package mechanical data

STF28N60DM2

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2



5 Revision history

Table 11: Document revision history

Date	Revision	Changes
04-Sep-2014	1	First release.
04-Sep-2014 09-Oct-2015	2	First release. Text and formatting changes throughout document On cover page: - upated title and Features table In section Electrical ratings: - updated all table data In section Electrical characteristics: - updated all table data - renamed table Static (was On /off states) - added table Gate-source Zener diode Added section Electrical characteristics (curves) Updated and renamed section Package mechanical data (was Package information)
		Datasheet promoted from preliminary to production data



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